

**Device Marking** 

.886

**Package Marking and Ordering Information** 

Device

FDC8886

Reel Size

7"

Tape Width

8 mm

Package

SSOT-6

Quantity

3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$ , referenced to 25 °C		18		mV/°0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	1.2	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		-6		mV/°0
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$		19	23	
		$V_{GS} = 4.5 \text{ V}, \ I_D = 6.0 \text{ A}$		30	36	mΩ
		$V_{GS}$ = 10 V, $I_D$ = 6.5 A, $T_J$ = 125 °C		25	30	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = 5 V, I_D = 6.5 A$		24		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			348	465	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$		135	180	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1 MHz		16	25	pF
R <sub>g</sub>	Gate Resistance			1.2		Ω
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			5	10	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 15 V, I <sub>D</sub> = 6.5 A,		1	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		11	19	ns
t <sub>f</sub>	Fall Time			1	10	ns
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		5.3	7.4	nC
	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$		2.5	3.5	nC
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 6.5 A		1.0		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			0.8		nC

V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 6.5 A$ (Note 2)	0.86	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 6.5 A, di/dt = 100 A/μs	14	22	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$-1F = 0.5 \text{ A}, \text{ u/u} = 100 \text{ A/} \mu \text{s}$ 3		10	nC
NOTES					

 $R_{0,LC}$  is guaranteed by design while  $R_{0CA}$  is determined by the user's board design.



a. 78 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

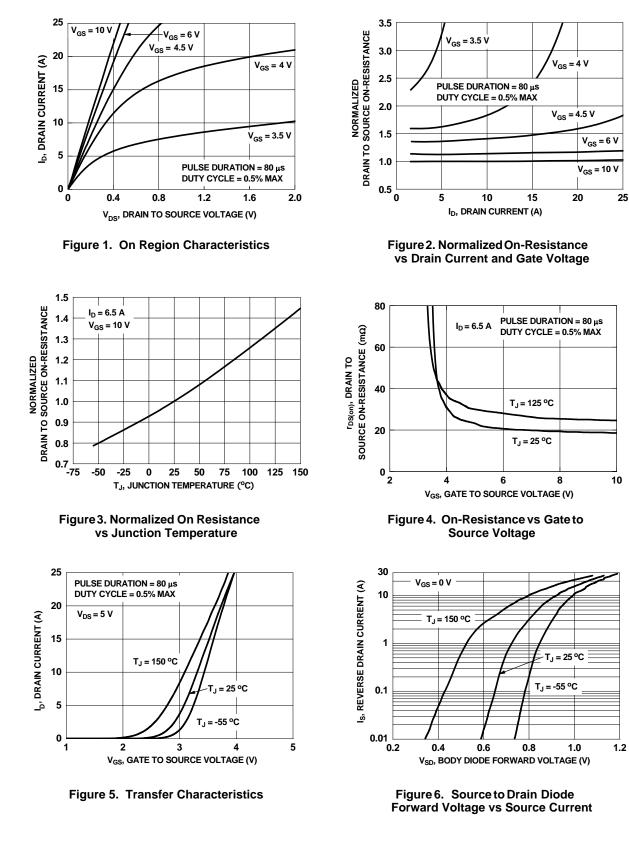


b.175 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

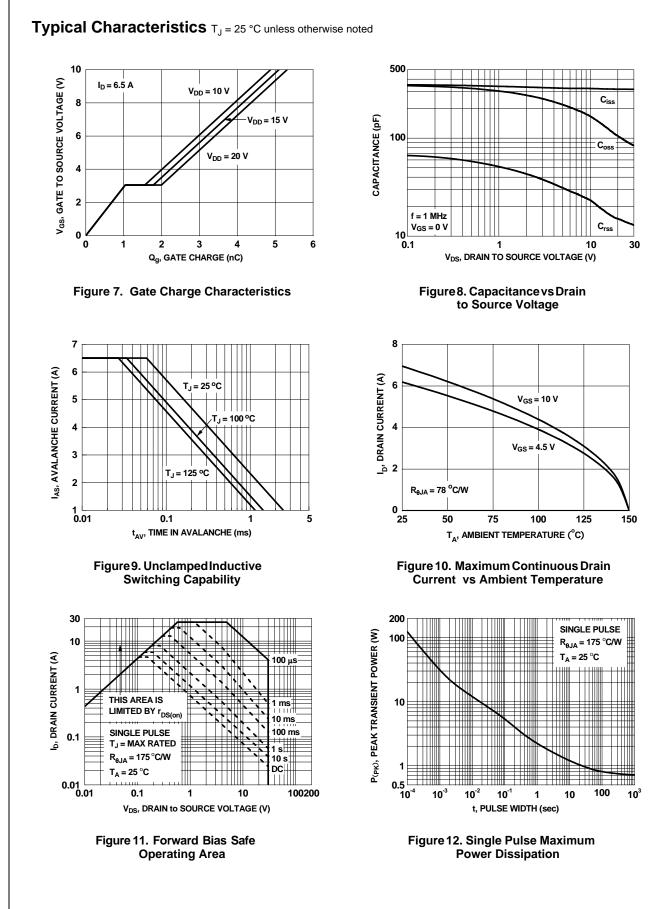
3. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

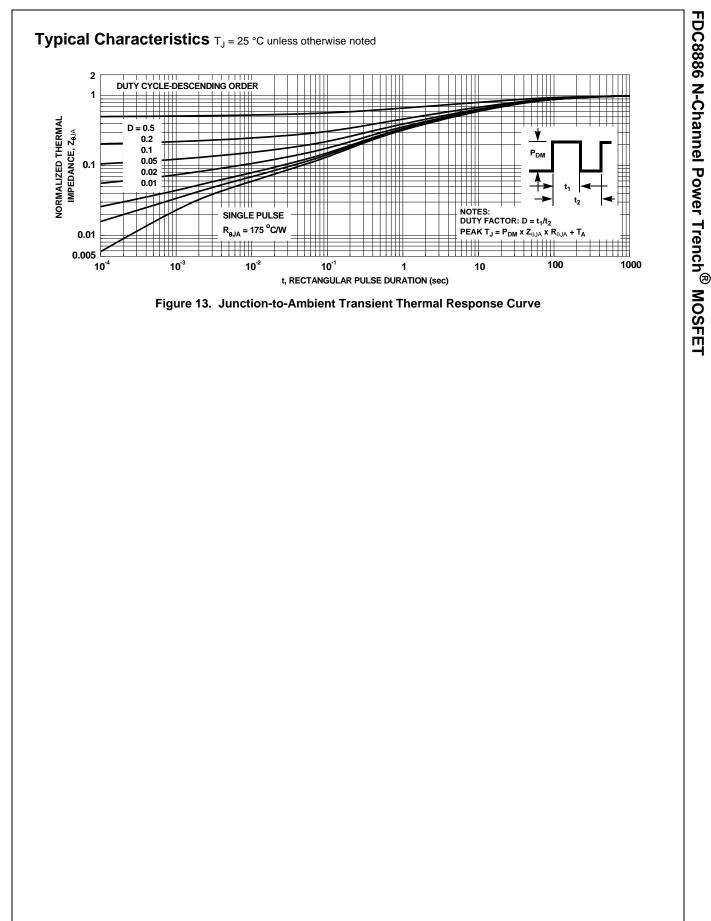
2

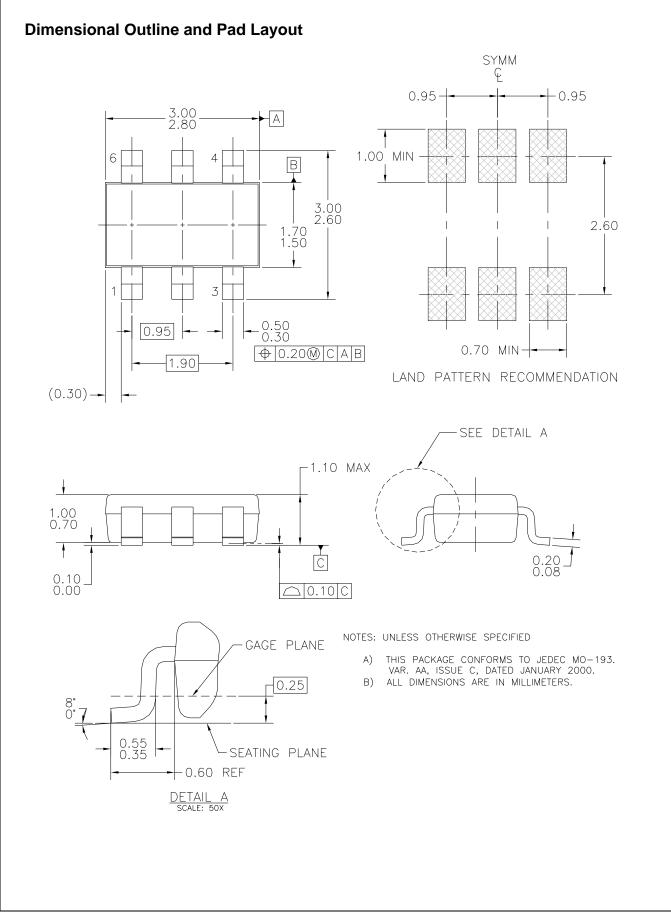


# **Typical Characteristics** T<sub>J</sub> = 25 °C unless otherwise noted









FDC8886 N-Channel Power Trench<sup>®</sup> MOSFET

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